

## 4-port lvds and 4-port TTL-to LVDS repeaters

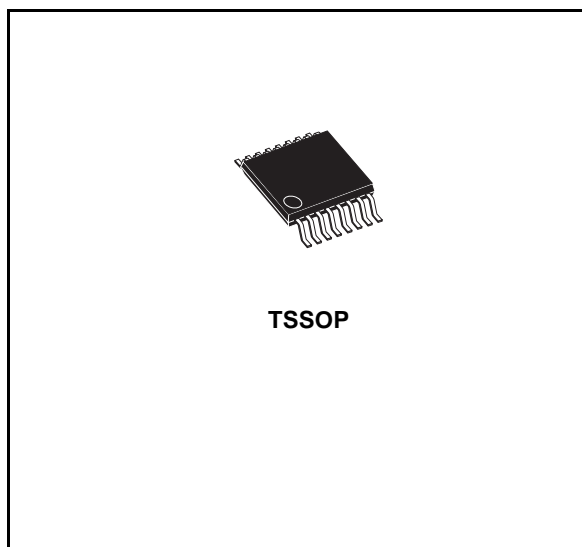
### Feature summary

- Receiver and drivers meet or exceed the requirements of ansi eia/tia-644 standard, receivers differential input levels,  $\pm 100\text{mV}$
- Designed for signaling rates up to 630mbps
- Operates from a single 3.3V supply
- Low voltage differential signaling with typical output voltage of 350mV and a 100 $\Omega$  load
- Propagation delay time: 3.1ns (typ)
- Electrically compatible with LVDS, PECL, LVPECL, LVTTTL, LVCOMOS, GTL, BTL, CTT, SSTL, or HSTL outputs with external network
- Bus terminal ESD (HBM) exceeds 7kV
- TSSOP package

### Description

The STLVDS104 is a differential line receiver and a LVTTTL input connected to four differential line drivers that implement the electrical characteristics of low voltage differential signaling, for point to point baseband data transmission over controlled impedance media of approximately 100 $\Omega$ . The transmission media can be printed-circuit board traces, backplanes, or cable.

LVDS, as specified in EIA/TIA-644 is a data signaling technique that offers low-power, low



noise coupling, and switching speed to transmit data at a speed up to 630Mbps at relatively long distances.

The drivers integrated into the same substrate, along with the low pulse skew of balanced signaling, allow extremely precise timing alignment of the signals repeated from the input.

The device allows extremely precise timing alignment of the signal repeated from the input. This is particularly advantageous in distribution or expansion of signals such as clock or serial data stream.

### Order codes

Type	Temperature Range	Package	Comments
STLVDS104BTR	-40 to 85 °C	TSSOP16 (Tape & Reel)	2500 parts per reel

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# 1 Pin configuration

Figure 1. Pin connections and functional diagram

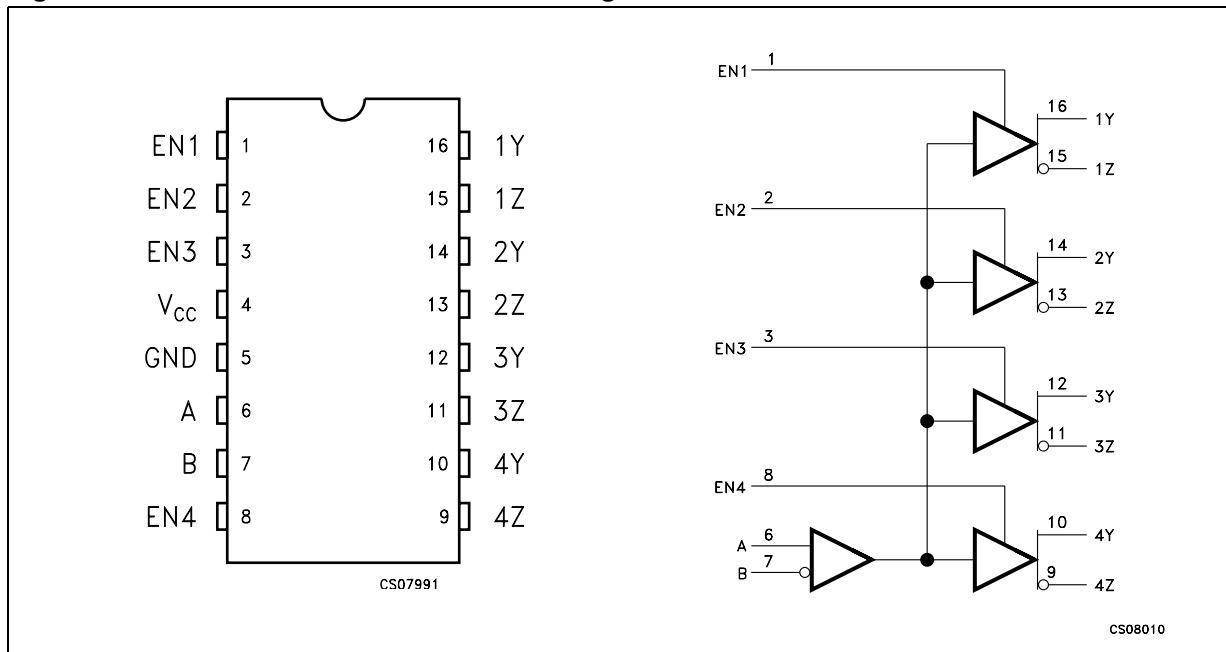


Table 1. Pin description

Pin n°	Symbol	Name and function
1, 2, 3, 8	EN1 to EN4	Enable Driver Inputs
6, 7	A, B	Receiver Input
9, 11, 13, 15	1Z to 4Z	Driver Inputs
10, 12, 14, 16	1X to 4X	Driver Inputs
5	GND	Ground
4	V <sub>CC</sub>	Supply Voltage

Table 2. Truth table for receiver

Input	Enables	Outputs	
		#Y	#Z
$V_{ID} = V_A - V_B$	#EN	#Y	#Z
X	X	Z	Z
X	L	Z	Z
$V_{ID} \geq 100mV$	H	H	L
$-100mV < V_{ID} < 100mV$	H	?	?
$V_{ID} \leq -100mV$	H	L	H

L=Low level, H=High level, X=Don't care, Z= High impedance,?=Indeterminate

## 2 Maximum ratings

**Table 3. Absolute maximum ratings**

Symbol	Parameter		Value	Unit
$V_{CC}$	Supply voltage (Note 1)		-0.5 to 4	V
$V_R$	Voltage range	Enable inputs	-0.5 to 6	V
		A, B, Y or Z	-0.5 to 4	V
ESD	ESD Protection voltage (HBM)	Y, Z, to GND	7	KV
		All Pins	2	KV
$T_{stg}$	Storage temperature range		-65 to +150	°C

Note: Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

Note: 1 All voltages except differential I/O bus voltage, are with respect to the network ground terminal.

**Table 4. Recommended operating conditions**

Symbol	Parameter	Min.	Typ.	Max.	Unit
$V_{CC}$	Supply voltage	3.0	3.3	3.6	V
$V_{IH}$	HIGH level input voltage	2.0			V
$V_{IL}$	LOW level input voltage			0.8	V
$ V_{ID} $	Magnitude of differential input voltage	0.1		3.6	V
$V_{IC}$	Common mode input voltage	$ V_{ID} /2$		$24- V_{ID} /2$	V
				$V_{CC}-0.8$	
$T_A$	Operating temperature range	-40		85	°C

### 3 Electrical characteristics

**Table 5. Electrical characteristics**

( $T_A = -40$  to  $85^\circ\text{C}$ , and  $V_{CC} = 3.3\text{V} \pm 10\%$  over recommended operating conditions unless otherwise noted. All typical values are at  $T_A = 25^\circ\text{C}$ ).

Symbol	Parameter	Test	Min.	Typ.	Max.	Unit
$V_{ITH+}$	Positive-going differential input voltage threshold				100	mV
$V_{ITH-}$	Negative-going differential input voltage threshold		-100			mV
$ V_{OD} $	Differential output voltage magnitude	$R_L = 100\Omega, V_{ID} = \pm 100\text{mV}$	247	340	454	mV
$\Delta V_{OD} $	Change in differential output voltage magnitude between logic state		-50		50	mV
$\Delta V_{OC(SS)}$	Change in steady-state common mode output voltage between logic state		-50		50	mV
$V_{OC(SS)}$	Steady-state Common Mode Output Voltage		1.125	1.2	1.375	V
$V_{OC(PP)}$	Peak to peak common mode output voltage			25	150	mV
$I_{CC}$	Supply current	Enabled, $R_L = 100\Omega$		20	30	mA
		Disabled		2.5	5	mA
$I_I$	Input current (A or B Inputs)	$V_I = 0\text{V}$	-2	-11	-20	$\mu\text{A}$
		$V_I = 2.4\text{V}$	-1	-3		$\mu\text{A}$
$I_{I(OFF)}$	Power OFF input current	$V_{CC} = 1.5\text{V}, V_I = 2.4\text{V}$		3	20	$\mu\text{A}$
$I_{IH}$	High level input current	$V_{IH} = 2\text{V}$		7	20	$\mu\text{A}$
$I_{IL}$	Low level input current	$V_{IL} = 0.8\text{V}$		3	10	$\mu\text{A}$
$I_{OC}$	Short circuit output current	$V_{O(Y)} \text{ or } V_{O(Z)} = 0\text{V}$		$\pm 6$	$\pm 10$	mA
		$V_{OD} = 0$		$\pm 3$	$\pm 10$	mA
$I_{OZ}$	High Impedance output current	$V_O = 0 \text{ or } 2.4\text{V}$			$\pm 1$	$\mu\text{A}$
$I_{O(OFF)}$	Power OFF output current	$V_{CC} = 1.5\text{V}, V_O = 2.4\text{V}$			$\pm 1$	$\mu\text{A}$
$C_{IN}$	Input capacitance (A or B inputs)	$V_I = 0.4 \sin(4e^{6\pi t}) + 0.5\text{V}$		3		pF
$C_O$	Output capacitance (Y or Z outputs)	$V_I = 0.4 \sin(4e^{6\pi t}) + 0.5\text{V}$ , Disabled		6		pF

**Table 6. Switching characteristics**

( $T_A = -40$  to  $85^\circ\text{C}$ , and  $V_{CC} = 3.3\text{V}$  unless otherwise noted. All typical values are at  $T_A = 25^\circ\text{C}$ ).

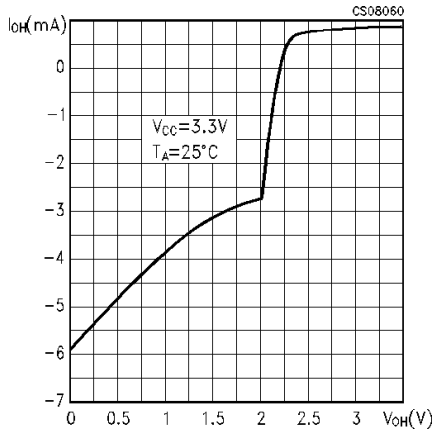
Symbol	Parameter	Test	Min.	Typ.	Max.	Unit
$t_{PLH}$	Propagation delay time, low to high output	$R_L = 100\Omega$ $C_L = 10\text{pF}$	2.4	3.2	4.2	ns
$t_{PHL}$	Propagation delay time, high to low output		2.2	3.1	4.2	ns
$t_r$	Differential output signal rise time		0.3	0.7	1.2	ns
$t_f$	Differential output signal fall time		0.3	0.7	1.2	ns
$t_{sk(P)}$	Pulse skew ( $ t_{THL} - t_{TLH} $ )			100	300	ps
$t_{sk(O)}$	Channel-to-channel output skew <sup>(1)</sup>			50	100	ps
$t_{sk(pp)}$	Part to part skew <sup>(2)</sup>			1.5	ns	
$t_{PZH}$	Propagation delay time, high impedance to high level output			7.2	15	ns
$t_{PZL}$	Propagation delay time, high impedance to low level output			8.4	15	ns
$t_{PHZ}$	Propagation delay time, high level to high impedance output			3.6	15	ns
$t_{PLZ}$	Propagation delay time, low level to high impedance output			6	15	ns

- $t_{sk(O)}$  is the time difference between the  $t_{PLH}$  or  $t_{PHL}$  of all drivers of a single device with all their inputs connected together
- $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuit

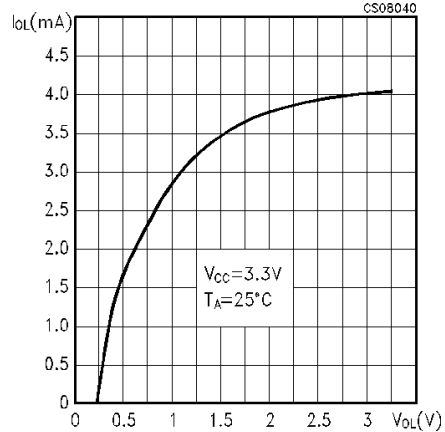
# 4 Typical performance characteristics

(Unless otherwise specified  $T_J = 25^\circ\text{C}$ )

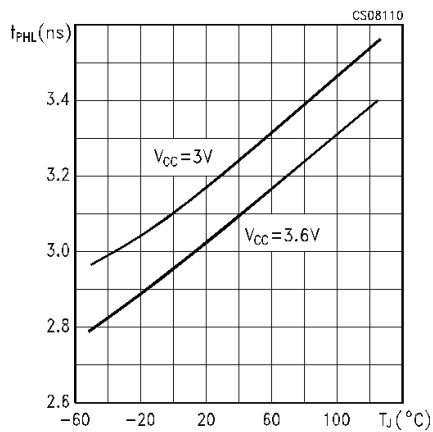
**Figure 2. Output current vs output high voltage**



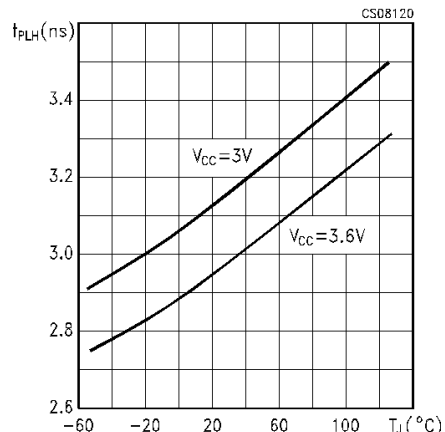
**Figure 3. Output current vs output low voltages**



**Figure 4. High to low propagation delay time**



**Figure 5. Low to high propagation delay time**



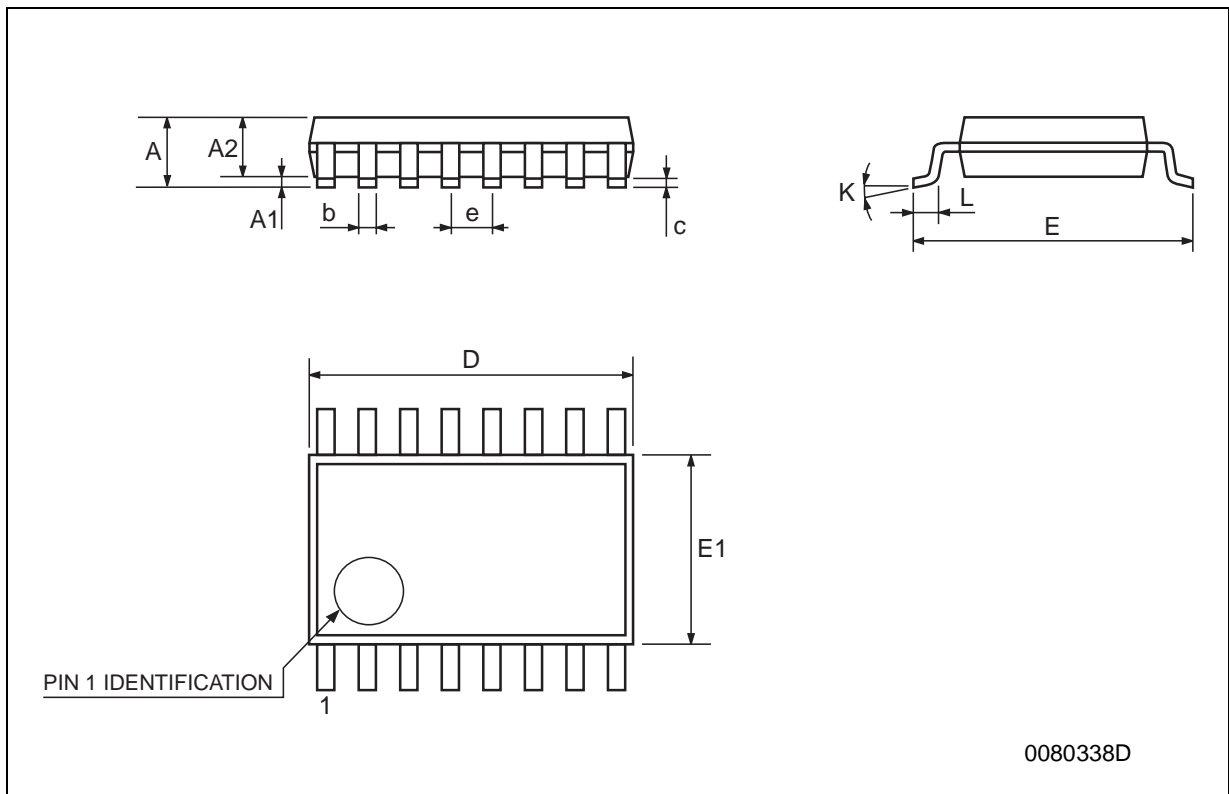
## 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).



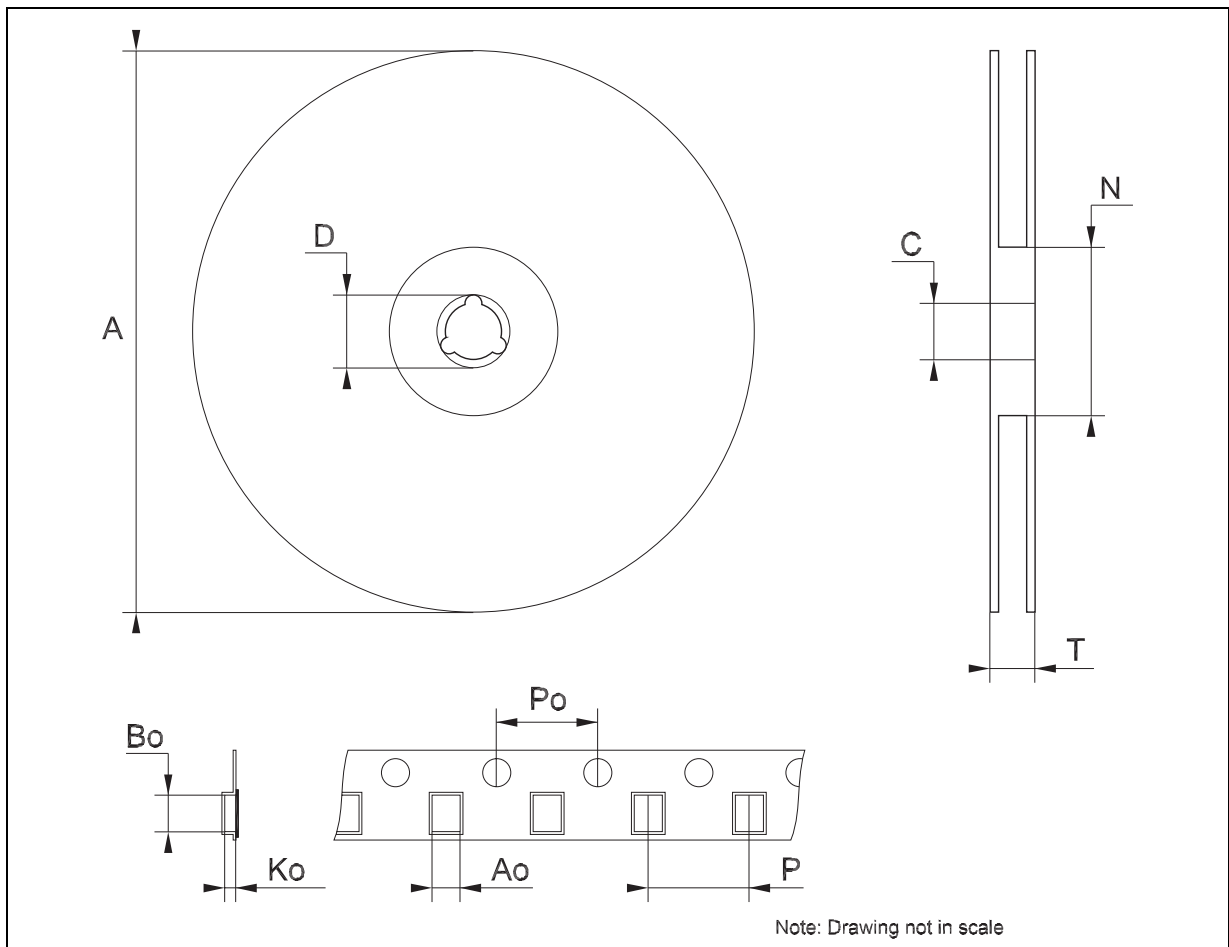
**TSSOP16 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0079
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



**Tape & Reel TSSOP16 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.7		6.9	0.264		0.272
Bo	5.3		5.5	0.209		0.217
Ko	1.6		1.8	0.063		0.071
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319



## 6 Revision history

**Table 7. Revision history**

Date	Revision	Changes
14-Mar-2006	5	Order codes has been updated and new template.

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